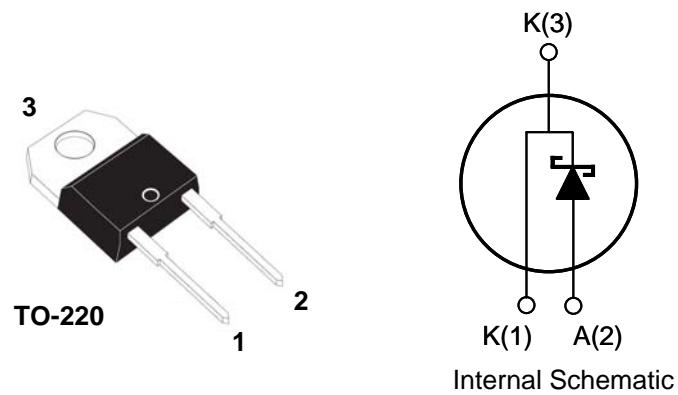


Silicon Carbide Power Schottky Diode

Features:

- Positive Temperature Coefficient for Ease of Parallelizing
- Temperature Independent Switching Behavior
- 175 °C Maximum Operating Temperature
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage

Product Summary		
V _{DC}	1200	V
I _F	10	A
Q _c	64	nC



Applications:

- Solar Inverter
- SMPS
- Power Factor Correction
- Induction Heating
- UPS
- Motor Drive

MAXIMUM RATINGS, at T_j = 25 C unless otherwise stated

Parameter	Symbol	Conditions	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}		1200	V
DC Blocking Voltage	V _{DC}		1200	
Continuous Forward Current	I _F	T _C < 145 °C	10	A
		T _C < 100 °C	18	
Repetitive Peak Forward Current	I _{F,RM}	T _j = 125 °C, D = 0.1	46	
Surge Non-Repetitive Forward Current, Half Sine Wave	I _{F,SM}	T _C = 25 °C, t _P = 10 ms	33	
Non-Repetitive Peak Forward Current	I _{F,max}	T _C = 25 °C, t _P = 10 us	225	
Power Dissipation	P _D	T _C = 25 °C	136	W
Operating and Storage Temperature	T _j , T _{j,stg}		-55 to +175	°C

THERMAL CHARACTERISTICS

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Thermal Resistance, junction-case	$R_{th,JC}$		-	1.1	-	$^{\circ}\text{C} / \text{W}$
Thermal Resistance, junction-ambient	$R_{th,JA}$		-	62	-	

ELECTRICAL CHARACTERISTICS, at $T_j = 25 \text{ C}$ unless otherwise stated

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Forward Voltage	V_F	$I_F = 10 \text{ A}, T_j = 25 \text{ }^{\circ}\text{C}$	-	1.6	1.8	V
		$I_F = 10 \text{ A}, T_j = 175 \text{ }^{\circ}\text{C}$	-	2.4	2.9	
Reverse Current	I_R	$V_R = 1200 \text{ V}, T_j = 25 \text{ }^{\circ}\text{C}$	-	10	100	uA
		$V_R = 1200 \text{ V}, T_j = 175 \text{ }^{\circ}\text{C}$	-	200	-	
Total Capacitive Charge	Q_C	$V_R = 1200 \text{ V}, I_F = 10 \text{ A}, \frac{dI}{dt} = 500\text{A/us}$	-	64	-	nC
Total Capacitance	C	$V_R = 0 \text{ V}, f = 100\text{kHz}$	-	1137	-	pF
		$V_R = 300 \text{ V}, f = 100\text{kHz}$	-	42	-	
		$V_R = 600 \text{ V}, f = 100\text{kHz}$	-	35	-	

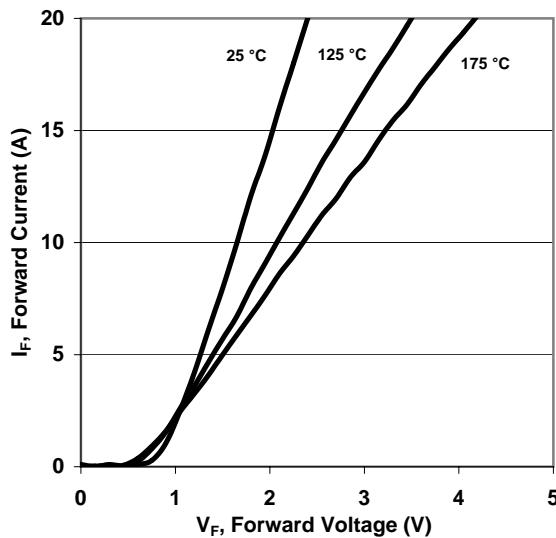


Figure 1. Typ. Forward Characteristics
 $I_F = f(V_F)$; parameter: T_j

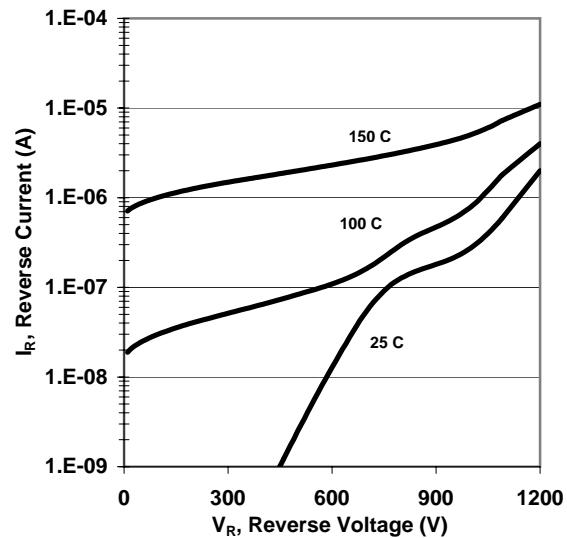


Figure 2. Typ. Reverse Characteristics
 $I_R = f(V_R)$

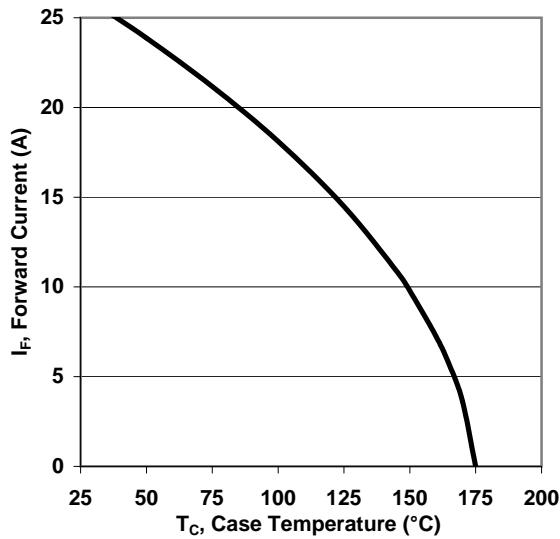


Figure 3. Diode Forward Current
 $I_F = f(T_C); T_j < 175 \text{ } ^\circ\text{C}; R_{th,JC(max)}$

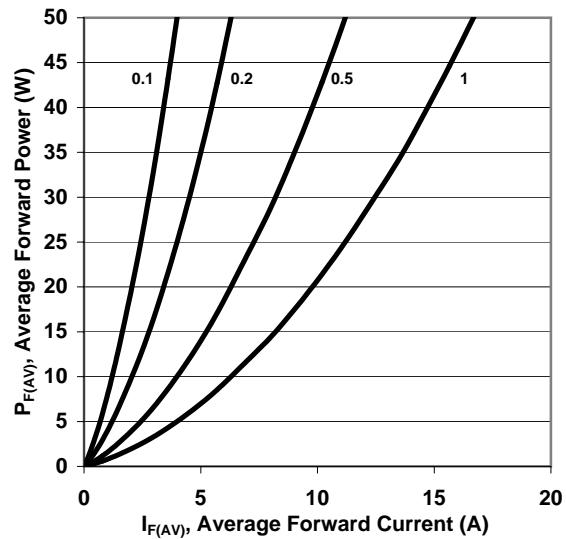


Figure 4. Typ. Forward Power Dissipation vs.
 Average Forward Current
 $P_F = f(I_F); T_C = 100 \text{ } ^\circ\text{C}; \text{parameter: } D = t_P/T$

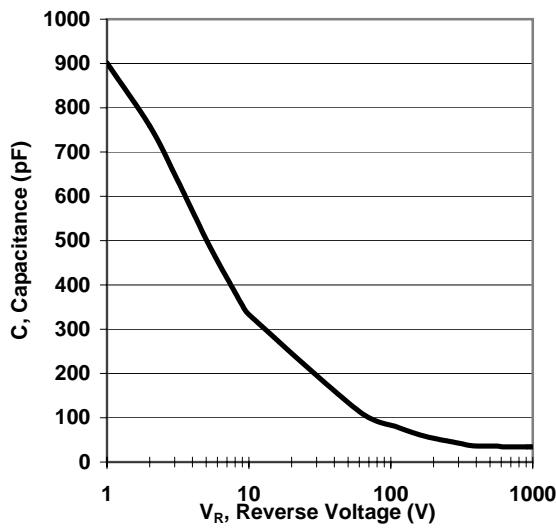


Figure 5. Typ. Capacitance vs.
 Reverse Voltage
 $C = f(V_R); T_C = 25 \text{ } ^\circ\text{C}; f = 1 \text{ MHz}$

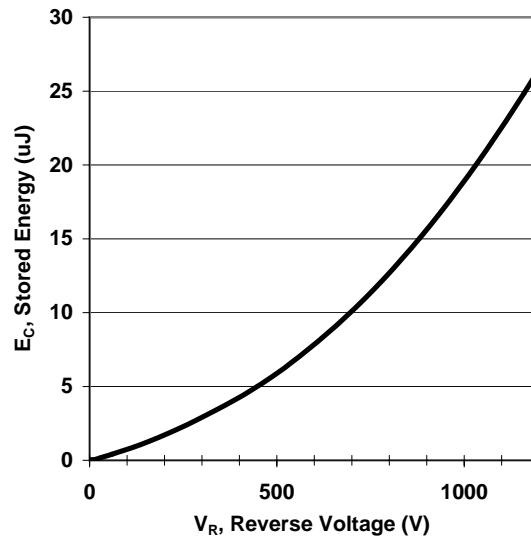


Figure 6. Typical Stored Energy vs.
 Reverse Voltage
 $E_C = f(V_R)$

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